ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights rese international and Pan-American copyright conventions.			All rights reserved und	der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility							ssembly with lowe responsibility.		
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					erials and I	ials and Mfg Information			
Supplier	· Information														
Company name* Company unique ID				ique ID	D Unique ID		Unique ID Au	ne ID Authority			Respon	Response Date*			
onsemi											2024-0	2024-05-01			
Contact N	ame	Title - Contact			1	Phone - Contact*				Email	Email - Contact*				
Product-E	Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Authorize	d Representative*	Title - Representative]	Phone - Representative*				Email	Email - Representative*				
Product-E	Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name			Effective Da	te Ve	e Version Manufacturing Site			Weight*	UOM	Unit Type		
		NCN515	NCN5150DR2G NCN5150 SOI		OAC		2024-05-01	5-01 BE4			139.69	mg	Each		
Manufa	cturing Proccess Informa	ation						,					,		
	Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Tempera		ture Max Time at Peak Tempera		ature Nu	mber of Reflow Cy	cles		
Matte Tin (Sn) - annealed			CU Alloy 2			260	C		30	seco	seconds 3				
comments															
TTENTI	ON: MSL 2 Rated item requir	es Dry Pack (a	fter electrica	l test)											
or more i	information regarding materia	l composition	please refer t	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.73	mg	Supplier	Silicon (Si)	7440-21-3		3.73	mg
Die Attach	1.85	mg		Resin	proprietary data		0.148	mg
			Supplier	Silver (Ag)	7440-22-4		1.5633	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.1388	mg
Lead Frame	75.92	mg	Supplier	Silver (Ag)	7440-22-4		0.6074	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0911	mg
			Supplier	Iron (Fe)	7439-89-6		1.7841	mg
			Supplier	Copper (Cu)	7440-50-8		73.4146	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0228	mg
Mold Compound-Black	54.11	mg		Epoxy resin	proprietary data		2.7055	mg
			Supplier	Phenolic Resin	Proprietary Data		1.0822	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.3528	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2705	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		48.699	mg
Plating	3.73	mg	Supplier	Tin (Sn)	7440-31-5		3.73	mg
Wire Bond - Au	0.35	mg	Supplier	Gold (Au)	7440-57-5		0.35	mg